

Material Composition for F11-201XXX42R

Product Information	
Part Number:	F11-201XXX42R
Part Description:	0.5mm Pitch Conn.
Part Weight (g):	(0.0162 * XXX) + 0.848

Process Data	
Peak Reflow (Deg. C)	260°C for 10 seconds
Termination Finish	Gold flash over Nickel
RoHS Compliant? (Y/N)	Yes

Note: Tin plating is subject to 1,000ppm max Lead impurity.

Homogeneous Material Location	Weight (g)	Tolerance	Substance Name	CAS #
Signal Contact - Copper Alloy	0.00587 * XXX	5%	Copper	7440-50-8
	0.000202 * XXX	1%	Nickel	7440-02-0
	0.000107 * XXX	0.5%	Magnesium	7439-95-4
	0.000044 * XXX	0.5%	Silicon	7440-21-3
Signal Contact - Plating	0.0001 * XXX	10%	Nickel	7440-02-0
	0.0001 * XXX	10%	Gold	7440-57-5
Power Contacts - Copper Alloy	0.0853	5%	Copper	7440-50-8
	0.00293	1%	Nickel	7440-02-0
	0.00156	0.5%	Magnesium	7439-95-4
	0.000641	0.5%	Silicon	7440-21-3
Power Contacts - Plating	0.0022	10%	Nickel	7440-02-0
	0.0022	10%	Gold	7440-57-5
Solder Clips - Brass	0.0354	5%	Copper	7440-50-8
	0.0183	1%	Zinc	7440-66-6
Solder Clips - Plating	0.0021	10%	Nickel	7440-02-0
	0.0021	10%	Tin	7440-31-5
Moulding (total weight)	(0.0098 * XXX) + 0.695	6%	33% GF LCP	
Containing:	(0.00637 * XXX) + 0.452	6%	Liquid Crystal Polymer	147310-94-9
	(0.00324 * XXX) + 0.23	6%	Glass Fibre	65997-17-3
	(0.000088 * XXX) + 0.00626	6%	Carbon Black	1333-86-4
	(0.000098 * XXX) + 0.00695	6%	Other	-

Prepared by: *M. J. Perry*

Martin J Perry, BSc(Eng) MSc CEng MIET
Compliance Specialist
ComplianceTeam@harwin.com

On behalf of:

